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# FQD10N20L

## N-Channel QFET® MOSFET

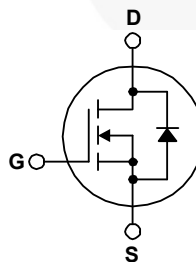
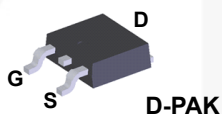
200 V, 7.6 A, 360 mΩ

### Description

This N-Channel enhancement mode power MOSFET is produced using Fairchild Semiconductor's proprietary planar stripe and DMOS technology. This advanced MOSFET technology has been especially tailored to reduce on-state resistance, and to provide superior switching performance and high avalanche energy strength. These devices are suitable for switched mode power supplies, active power factor correction (PFC), and electronic lamp ballasts.

### Features

- 7.6 A, 200 V,  $R_{DS(on)} = 360 \text{ m}\Omega$  (Max.) @  $V_{GS} = 10 \text{ V}$ ,  $I_D = 3.8 \text{ A}$
- Low Gate Charge (Typ. 13 nC)
- Low Crss (Typ. 14 pF)
- 100% Avalanche Tested
- Low Level Gate Drive Requirements Allowing Direct Operation Form Logic Drivers



### Absolute Maximum Ratings $T_C = 25^\circ\text{C}$ unless otherwise noted.

Symbol	Parameter	FQD10N20LTM	Unit
$V_{DSS}$	Drain-Source Voltage	200	V
$I_D$	Drain Current - Continuous ( $T_C = 25^\circ\text{C}$ )	7.6	A
	- Continuous ( $T_C = 100^\circ\text{C}$ )	4.8	A
$I_{DM}$	Drain Current - Pulsed (Note 1)	30.4	A
$V_{GSS}$	Gate-Source Voltage	$\pm 20$	V
$E_{AS}$	Single Pulsed Avalanche Energy (Note 2)	180	mJ
$I_{AR}$	Avalanche Current (Note 1)	7.6	A
$E_{AR}$	Repetitive Avalanche Energy (Note 1)	5.1	mJ
dv/dt	Peak Diode Recovery dv/dt (Note 3)	5.5	V/ns
$P_D$	Power Dissipation ( $T_A = 25^\circ\text{C}$ ) *	2.5	W
	Power Dissipation ( $T_C = 25^\circ\text{C}$ )	51	W
	- Derate above $25^\circ\text{C}$	0.4	W/ $^\circ\text{C}$
$T_J, T_{STG}$	Operating and Storage Temperature Range	-55 to +150	$^\circ\text{C}$
$T_L$	Maximum lead temperature for soldering, 1/8" from case for 5 seconds	300	$^\circ\text{C}$

### Thermal Characteristics

Symbol	Parameter	FQD10N20LTM	Unit
$R_{\theta JC}$	Thermal Resistance, Junction to Case, Max.	2.48	$^\circ\text{C}/\text{W}$
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient (Minimum Pad of 2-oz Copper), Max.	110	
	Thermal Resistance, Junction to Ambient (*1 in <sup>2</sup> Pad of 2-oz Copper), Max.	50	

## Package Marking and Ordering Information

Part Number	Top Mark	Package	Packing Method	Reel Size	Tape Width	Quantity
FQD10N20LTM	FQD10N20L	DPAK	Tape and Reel	330 mm	16 mm	2500 units

## Electrical Characteristics

$T_C = 25^\circ\text{C}$  unless otherwise noted.

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
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### Off Characteristics

$BV_{DSS}$	Drain-Source Breakdown Voltage	$V_{GS} = 0\text{ V}, I_D = 250\ \mu\text{A}$	200	--	--	V
$\Delta BV_{DSS} / \Delta T_J$	Breakdown Voltage Temperature Coefficient	$I_D = 250\ \mu\text{A}$ , Referenced to $25^\circ\text{C}$	--	0.18	--	$V/^\circ\text{C}$
$I_{DSS}$	Zero Gate Voltage Drain Current	$V_{DS} = 200\text{ V}, V_{GS} = 0\text{ V}$	--	--	1	$\mu\text{A}$
		$V_{DS} = 160\text{ V}, T_C = 125^\circ\text{C}$	--	--	10	$\mu\text{A}$
$I_{GSSF}$	Gate-Body Leakage Current, Forward	$V_{GS} = 20\text{ V}, V_{DS} = 0\text{ V}$	--	--	100	nA
$I_{GSSR}$	Gate-Body Leakage Current, Reverse	$V_{GS} = -20\text{ V}, V_{DS} = 0\text{ V}$	--	--	-100	nA

### On Characteristics

$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = 250\ \mu\text{A}$	1.0	--	2.0	V
$R_{DS(on)}$	Static Drain-Source On-Resistance	$V_{GS} = 10\text{ V}, I_D = 3.8\text{ A}$	--	0.29	0.36	$\Omega$
		$V_{GS} = 5\text{ V}, I_D = 3.8\text{ A}$	--	0.3	0.38	
$g_{FS}$	Forward Transconductance	$V_{DS} = 30\text{ V}, I_D = 3.8\text{ A}$	--	9.6	--	S

### Dynamic Characteristics

$C_{iss}$	Input Capacitance	$V_{DS} = 25\text{ V}, V_{GS} = 0\text{ V},$ $f = 1.0\text{ MHz}$	--	640	830	pF
$C_{oss}$	Output Capacitance		--	95	125	pF
$C_{rss}$	Reverse Transfer Capacitance		--	14	18	pF

### Switching Characteristics

$t_{d(on)}$	Turn-On Delay Time	$V_{DD} = 100\text{ V}, I_D = 10\text{ A},$ $R_G = 25\ \Omega$	--	13	35	ns	
$t_r$	Turn-On Rise Time		--	150	310	ns	
$t_{d(off)}$	Turn-Off Delay Time		(Note 4)	--	50	110	ns
$t_f$	Turn-Off Fall Time		--	95	200	ns	
$Q_g$	Total Gate Charge	$V_{DS} = 160\text{ V}, I_D = 10\text{ A},$ $V_{GS} = 5\text{ V}$	--	13	17	nC	
$Q_{gs}$	Gate-Source Charge		(Note 4)	--	2.4	--	nC
$Q_{gd}$	Gate-Drain Charge		--	6.1	--	nC	

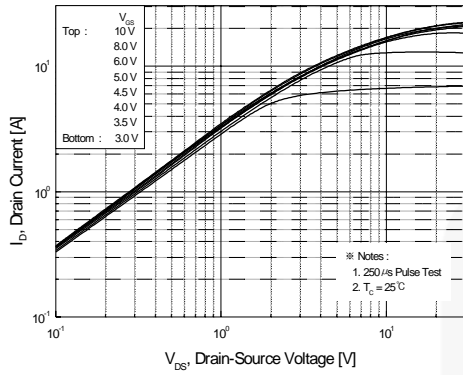
### Drain-Source Diode Characteristics and Maximum Ratings

$I_S$	Maximum Continuous Drain-Source Diode Forward Current	--	--	7.6	A	
$I_{SM}$	Maximum Pulsed Drain-Source Diode Forward Current	--	--	30.4	A	
$V_{SD}$	Drain-Source Diode Forward Voltage	$V_{GS} = 0\text{ V}, I_S = 7.6\text{ A}$	--	--	1.5	V
$t_{rr}$	Reverse Recovery Time	$V_{GS} = 0\text{ V}, I_S = 10\text{ A},$	--	120	--	ns
$Q_{rr}$	Reverse Recovery Charge	$di_F / dt = 100\text{ A}/\mu\text{s}$	--	0.57	--	$\mu\text{C}$

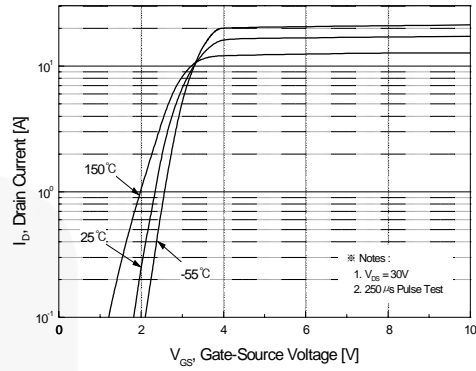
#### Notes:

1. Repetitive rating : pulse-width limited by maximum junction temperature.
2.  $L = 4.7\text{ mH}, I_{AS} = 7.6\text{ A}, V_{DD} = 50\text{ V}, R_G = 25\ \Omega$ , starting  $T_J = 25^\circ\text{C}$ .
3.  $I_{SD} \leq 10\text{ A}, di/dt \leq 300\text{ A}/\mu\text{s}, V_{DD} \leq BV_{DSS}$ , starting  $T_J = 25^\circ\text{C}$ .
4. Essentially independent of operating temperature.

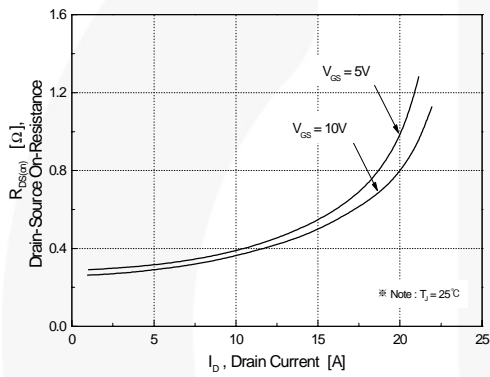
## Typical Characteristics



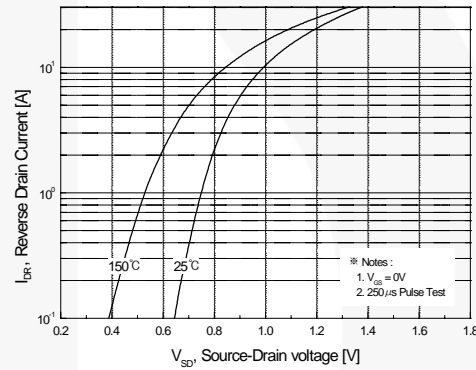
**Figure 1. On-Region Characteristics**



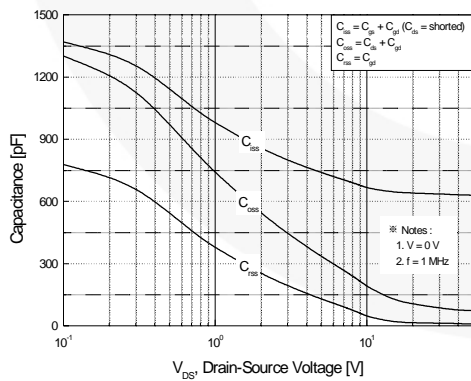
**Figure 2. Transfer Characteristics**



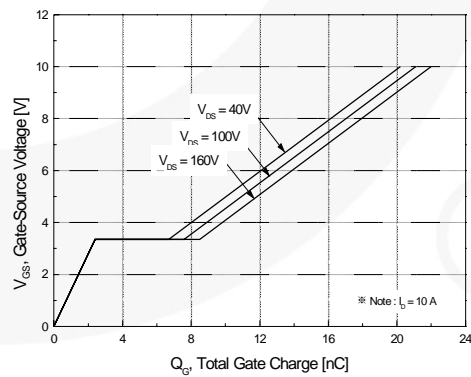
**Figure 3. On-Resistance Variation vs. Drain Current and Gate Voltage**



**Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature**

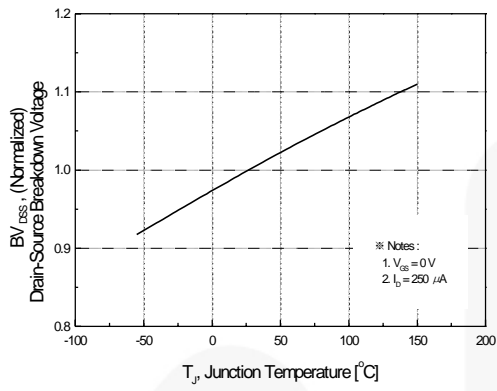


**Figure 5. Capacitance Characteristics**

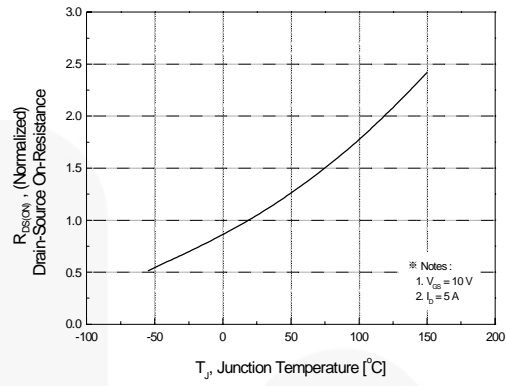


**Figure 6. Gate Charge Characteristics**

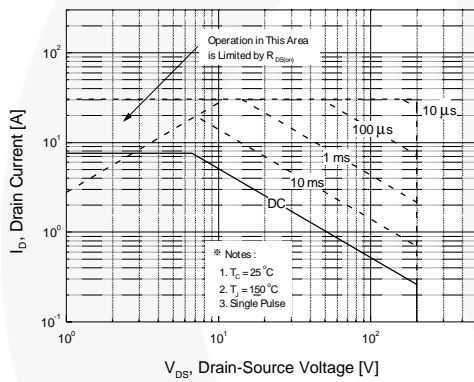
**Typical Characteristics** (Continued)



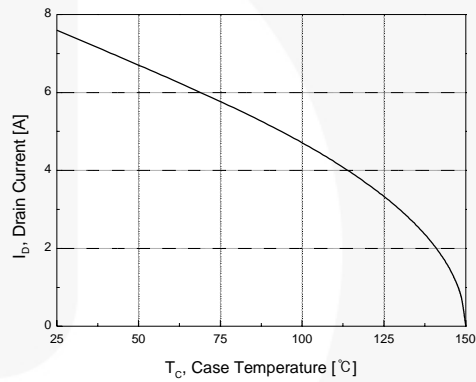
**Figure 7. Breakdown Voltage Variation vs. Temperature**



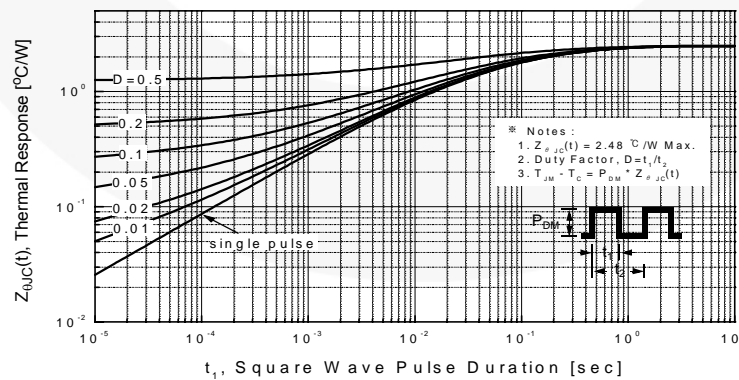
**Figure 8. On-Resistance Variation vs. Temperature**



**Figure 9. Maximum Safe Operating Area**



**Figure 10. Maximum Drain Current vs. Case Temperature**



**Figure 11. Transient Thermal Response Curve**



Figure 12. Gate Charge Test Circuit & Waveform



Figure 13. Resistive Switching Test Circuit & Waveforms

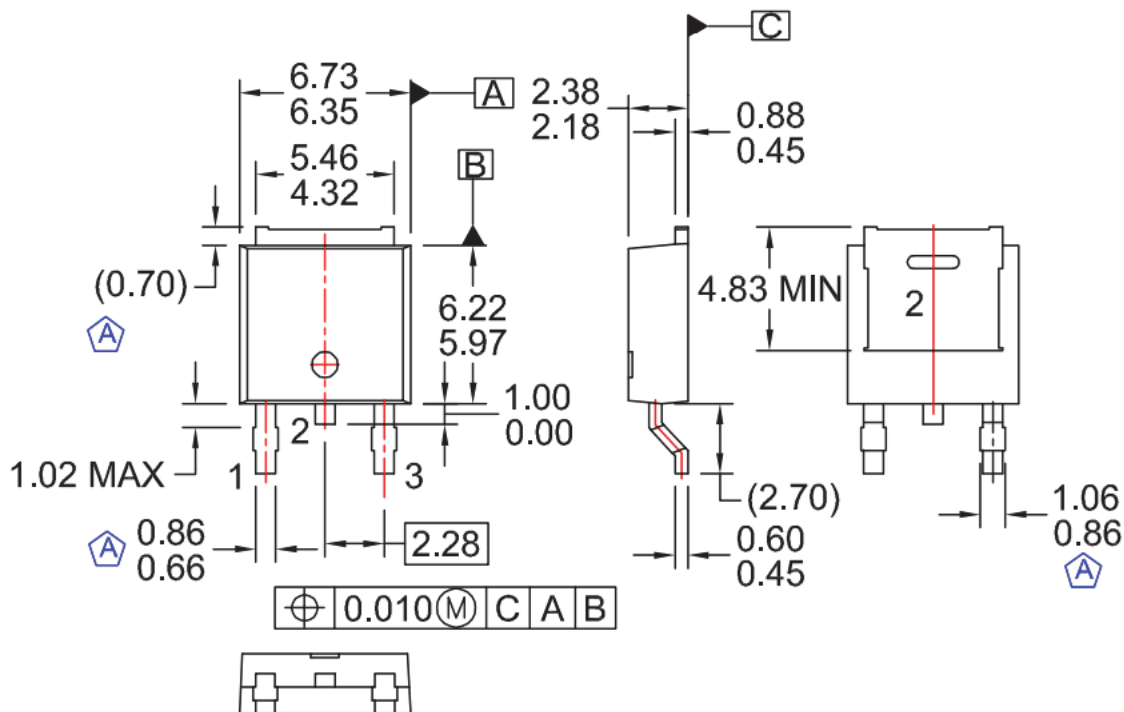


Figure 14. Unclamped Inductive Switching Test Circuit & Waveforms



Figure 15. Peak Diode Recovery  $dv/dt$  Test Circuit & Waveforms

## Mechanical Dimensions



- NOTES: UNLESS OTHERWISE SPECIFIED
- A) CONFORMS TO JEDEC TO-252 VARIATION AB EXCEPT WHERE NOTED
  - B) ALL DIMENSIONS ARE IN MILLIMETERS.
  - C) DRAWING CONFORMS TO ASME Y14.5M-1994
  - D) DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS.
  - E) FORMERLY NAMED BD1733
  - F) DRAWING FILE NAME: MKT-TO252D03REV1

**Figure 16. TO-252 (D-PAK), Molded, 3-Lead, Jedec TO-252 VAR. AB, Surface Mount**

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| Build it Now™            | GreenBridge™                                    | QFET®                      | TinyBuck®        |
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| EcoSPARK®                | MegaBuck™                                       |                            | TriFault Detect™ |
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